Silicon N-Channel/P-Channel Power MOS FET Array

# HITACHI

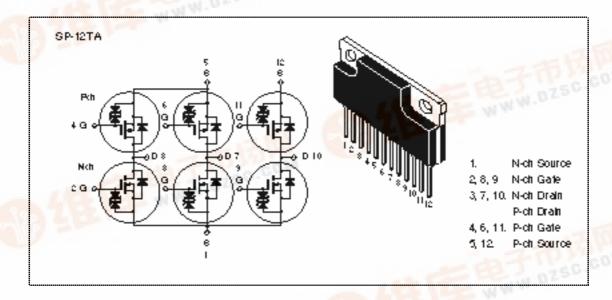
#### **Application**

High speed power switching Warris G. GODA

#### **Features**

- Low on-resistance
- Low drive current
- High speed switching
- High density mounting

#### **Outline**





### **Absolute Maximum Ratings** $(Ta = 25^{\circ}C)$

		Ratings		
Item	Symbol	Nch	Pch	 Unit
Drain to source voltage	V <sub>DSS</sub>	60	-60	V
Gate to source voltage	V <sub>GSS</sub>	±20	±20	V
Drain current	lD	7	<b>-7</b>	A
Drain peak current	I <sub>D(pulse)</sub> *1	28	-28	Α
Reverse drain current	I <sub>DR</sub>	7	<b>-</b> 7	А
Channel dissipation	Pch* <sup>2</sup>	42		W
Channel dissipation	Pch* <sup>2</sup>	4.8		W
Channel temperature	Tch	150		°C
Storage temperature	Tstg	–55 to		°C

Notes: 1. PW 10 µs, duty cycle 1%

2. Value at 6 Drive operation



### Electrical Characteristics N Channel ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V <sub>(BR)DS</sub> S	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V <sub>(BR)</sub> GS S	±20	—	—	V	$I_G = \pm 100  \mu A,  V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	<u>—</u>	<u>—</u>	250	μΑ	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	<sup>V</sup> GS(off)	0.5	<u>—</u>	1.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state	R <sub>DS(on)</sub>	_	0.14	0.2		I <sub>D</sub> = 4 A
resistance						$V_{GS} = 4 V^{*1}$
		_	0.22	0.5		I <sub>D</sub> = 2 A
						$V_{GS} = 2.5 V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	4.0	6.5	<u> </u>	S	I <sub>D</sub> = 4 A
						$V_{DS} = 10 \ V^{*1}$
Input capacitance	Ciss	<u> </u>	500	<u> </u>	pF	V <sub>DS</sub> = 10 V
Output capacitance	Coss	—	240	<u>—</u>	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	<u> </u>	30	<u> </u>	pF	f = 1 MHz
Turn-on delay time	<sup>t</sup> d(on)	—	15	<u>—</u>	ns	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A
Rise time	t <sub>r</sub>	—	90	—	ns	R <sub>L</sub> = 7.5
Turn-off delay time	<sup>t</sup> d(off)	—	110	—	ns	•
Fall time	t <sub>f</sub>	—	250	—	ns	•
Body to drain diode forward voltage	V <sub>DF</sub>	—	1.0	—	V	I <sub>F</sub> = 7 A, V <sub>GS</sub> = 0
Body to drain diode reverse recovery time	<sup>t</sup> rr	<u> </u>	170		ns	$I_F = 7 \text{ A}, V_{GS} = 0$ diF/dt = 50 A/ $\mu$ s

Note: 1. Pulse Test



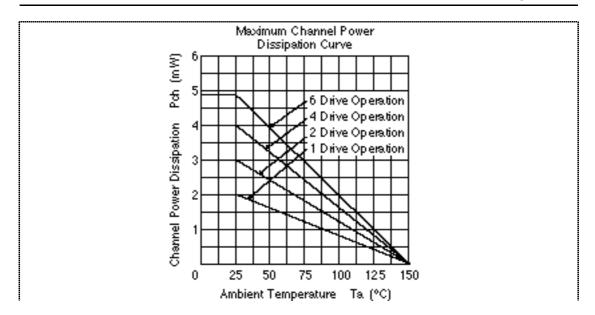
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### Electrical Characteristics P Channel ( $Ta = 25^{\circ}C$ )

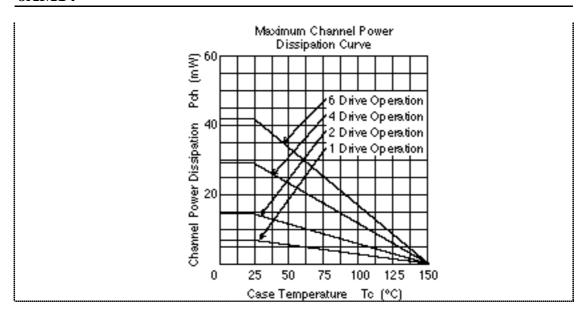
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V <sub>(BR)DS</sub> S	-60	_	_	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V <sub>(BR)</sub> GS S	±20	<u>—</u>	<del></del>	V	$I_G = \pm 100  \mu A,  V_{DS} = 0$
Gate to source leak current	l <sub>GSS</sub>	—	—	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	-250	μΑ	$V_{DS} = -50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	VGS(off)	-0.5	<u>—</u>	-1.5	V	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$
Static drain to source on state	R <sub>DS(on)</sub>	<u> </u>	0.12	0.16		I <sub>D</sub> = -4 A
resistance						$V_{GS} = -4 V^{*1}$
		_	0.16	0.3		I <sub>D</sub> = −2 A
						$V_{GS} = -2.5 \text{ V}^{*1}$
Forward transfer admittance	y <sub>fs</sub>	5.0	8.0	<u> </u>	S	I <sub>D</sub> = -4 A
						$V_{DS} = -10 \text{ V}^{*1}$
Input capacitance	Ciss	—	1450	—	pF	V <sub>DS</sub> = -10 V
Output capacitance	Coss		590	<u>—</u>	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	120	_	pF	f = 1 MHz
Turn-on delay time	<sup>t</sup> d(on)	—	15	_	ns	$V_{GS} = -10 \text{ V}, I_D = -4 \text{ A}$
Rise time	t <sub>r</sub>		75		ns	 R <sub>L</sub> = 7.5
Turn-off delay time	<sup>t</sup> d(off)	—	240	—	ns	•
Fall time	t <sub>f</sub>		180		ns	•
Body to drain diode forward voltage	V <sub>DF</sub>	—	-1.0	—	V	$I_F = -7 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	<sup>t</sup> rr	<u> </u>	210	<u> </u>	ns	$I_F = -7 \text{ A, V}_{GS} = 0$ diF/dt = 50 A/ $\mu$ s

Note: 1. Pulse Test











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